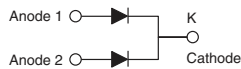
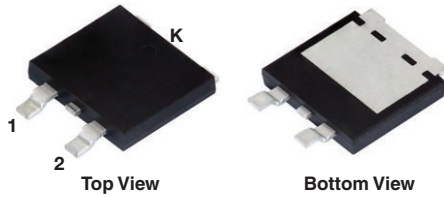


# Dual High-Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

 Ultra Low  $V_F = 0.46\text{ V}$  at  $I_F = 5.0\text{ A}$ 

## eSMP® Series SMPD (TO-263AC)



### LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS                                |                 |
|--|-----------------|
| $I_{F(AV)}$  | 2 x 15 A        |
| $V_{RRM}$  | 100 V           |
| $I_{FSM}$  | 150 A           |
| $V_F$ at $I_F = 15\text{ A}$ ( $T_A = 125\text{ °C}$ ) | 0.64 V          |
| $T_J$ max.   | 150 °C          |
| Package  | SMPD (TO-263AC) |
| Circuit configuration                                  | Common cathode  |

### FEATURES

- Trench MOS Schottky technology
- Very low profile - typical height of 1.7 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available:
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

### MECHANICAL DATA

**Case:** SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

**Polarity:** as marked

| MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)                     |                            |             |      |
|--|----------------------------|-------------|------|
| PARAMETER  | SYMBOL                     | V30D100C    | UNIT |
| Device marking code  |                            | V30D100C    |      |
| Maximum repetitive peak reverse voltage  | $V_{RRM}$                  | 100         | V    |
| Maximum average forward rectified current (fig. 1)                                 | $I_{F(AV)}$ <sup>(1)</sup> | per device  | 30   |
|  |                            | per diode   | 15   |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | $I_{FSM}$                  | 150         | A    |
| Operating junction temperature range   | $T_J$ <sup>(2)</sup>       | -40 to +150 | °C   |
| Storage temperature range  | $T_{STG}$                  | -55 to +150 |      |

### Notes

(1) Mounted on infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$

| <b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) |                      |                                   |             |      |      |    |
|--|----------------------|-----------------------------------|-------------|------|------|----|
| PARAMETER  | TEST CONDITIONS      | SYMBOL                            | TYP.        | MAX. | UNIT |    |
| Instantaneous forward voltage per diode  | $I_F = 5\text{ A}$   | $T_A = 25\text{ }^\circ\text{C}$  | $V_F^{(1)}$ | 0.52 | -    | V  |
|  | $I_F = 7.5\text{ A}$ |                                   |             | 0.58 | -    |    |
|  | $I_F = 15\text{ A}$  |                                   |             | 0.74 | 0.82 |    |
|  | $I_F = 5\text{ A}$   | $T_A = 125\text{ }^\circ\text{C}$ |             | 0.46 | -    |    |
|  | $I_F = 7.5\text{ A}$ |                                   |             | 0.53 | -    |    |
|  | $I_F = 15\text{ A}$  |                                   |             | 0.64 | 0.72 |    |
| Reverse current per diode  | $V_R = 70\text{ V}$  | $T_A = 25\text{ }^\circ\text{C}$  | $I_R^{(2)}$ | 0.01 | -    | mA |
|  |                      | $T_A = 125\text{ }^\circ\text{C}$ |             | 5    | -    |    |
|  | $V_R = 100\text{ V}$ | $T_A = 25\text{ }^\circ\text{C}$  |             | -    | 0.5  |    |
|  |                      | $T_A = 125\text{ }^\circ\text{C}$ |             | 10   | 25   |    |
| Typical junction capacitance   | 4.0 V, 1 MHz         | $C_J$                             | 1250        | -    | pF   |    |

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
 (2) Pulse test: Pulse width  $\leq 5\text{ ms}$

| <b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) |                          |          |                    |
|---|--------------------------|----------|--------------------|
| PARAMETER   | SYMBOL                   | V30D100C | UNIT               |
| Typical thermal resistance per device   | $R_{\theta JC}^{(1)}$    | 1.6      | $^\circ\text{C/W}$ |
|   | $R_{\theta JA}^{(2)(3)}$ | 48       |                    |

**Notes**

- (1) Mounted on infinite heatsink  
 (2) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$   
 (3) Free air, without heatsink

| <b>ORDERING INFORMATION</b> (Example) |                 |                        |               |                                    |
|---------------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N                         | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
| V30D100C-M3/I                         | 0.55            | I                      | 2000/reel     | 13" diameter plastic tape and reel |
| V30D100CHM3/I <sup>(1)</sup>          | 0.55            | I                      | 2000/reel     | 13" diameter plastic tape and reel |

**Note**

- (1) AEC-Q101 qualified

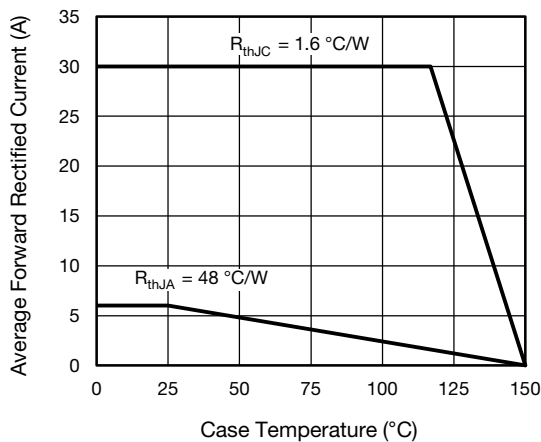
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

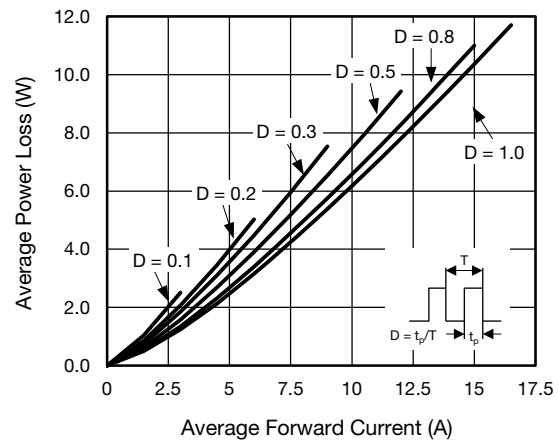


Fig. 2 - Average Power Loss Characteristics

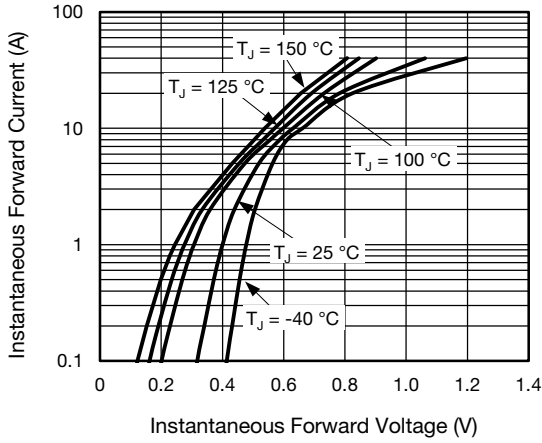


Fig. 3 - Typical Instantaneous Forward Characteristics

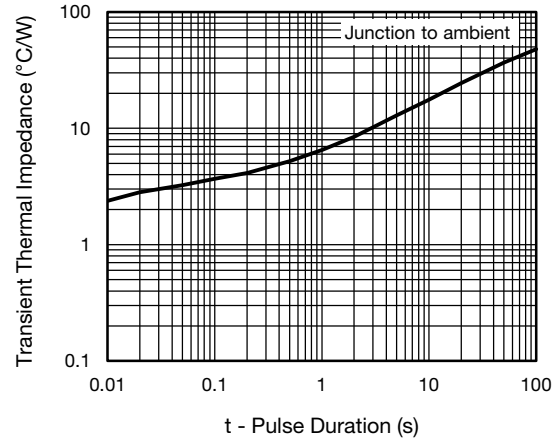


Fig. 6 - Typical Transient Thermal Impedance

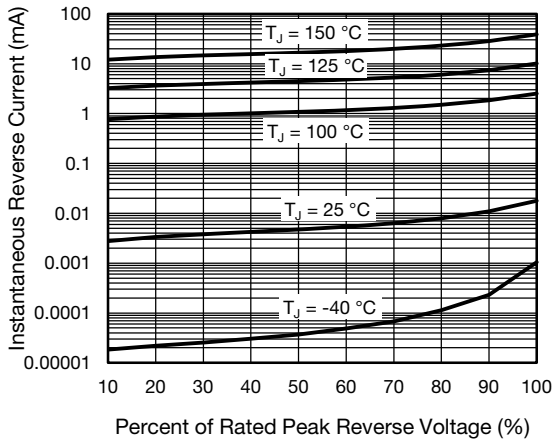


Fig. 4 - Typical Reverse Leakage Characteristics

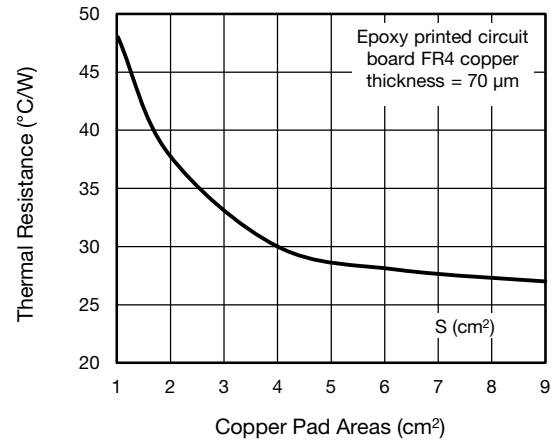


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

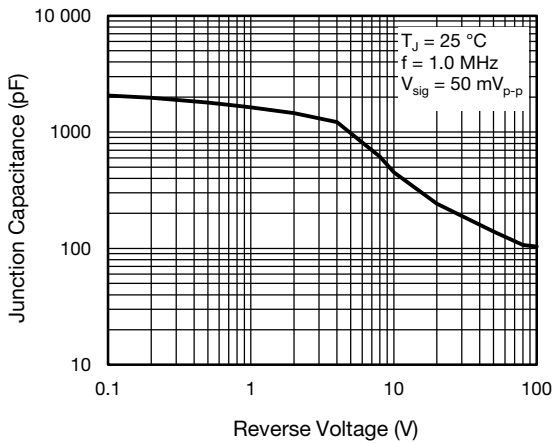
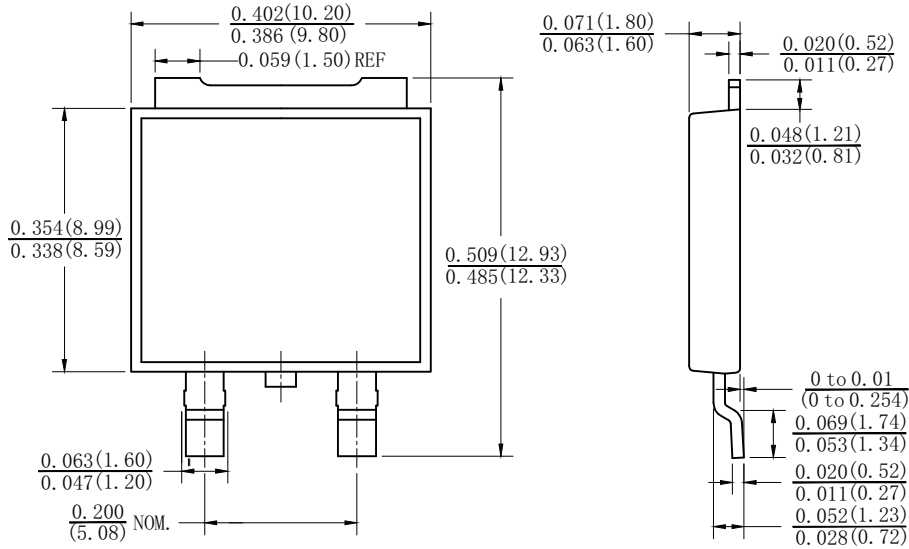


Fig. 5 - Typical Junction Capacitance

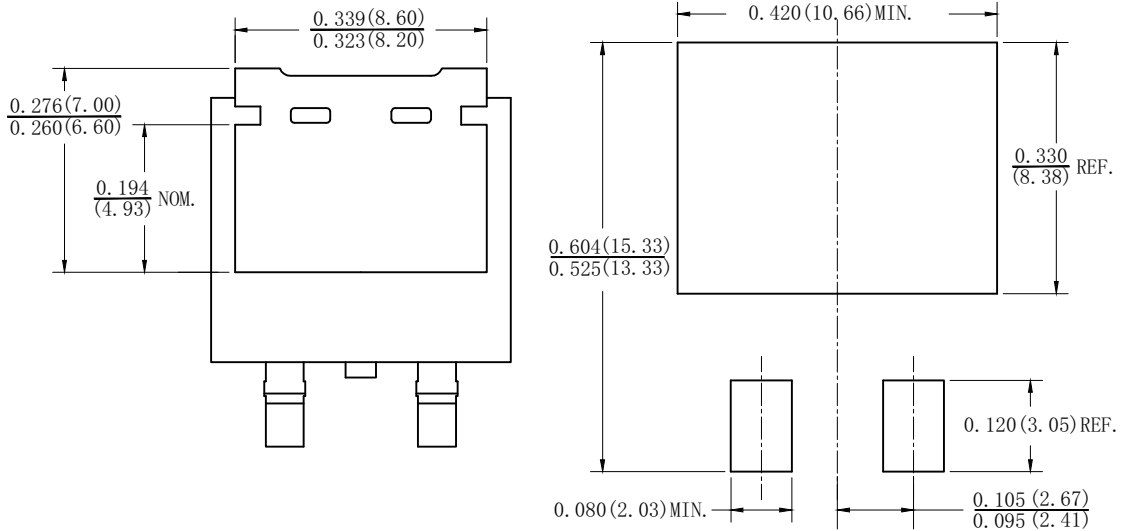


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPD (TO-263AC)



Mounting Pad Layout





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